

CALL FOR PAPERS

Special Session 4 “Wellbeing and Affective Engineering”

34th ACIS International Conference on Software Engineering, Artificial Intelligence, Networking and Parallel/Distributed Computing (SNPD2026-I)

<https://acisinternational.org/conferences/snpd-2026-i/>

August 22-24, 2026, Okayama, Japan

Overview:

Advances in information and communication technologies have brought tremendous benefits to us. These benefits include improvement of the way of life. Information and communication technologies may help us to live more comfortably and more happily. Affective engineering, which is engineering using affective information, may bring the state of wellbeing to human beings.

This special session treats all aspects on wellbeing and affective engineering, which include clarifying the principle of wellbeing induced by affective engineering, realizing wellbeing state, clarifying the effect of wellbeing, and broadening the applications of wellbeing.

This special session encourages participants to discuss their research results, to exchange ideas, and to promote research on wellbeing and affective engineering.

Important Dates:

- Paper Submission: *June 1, 2026*
- Acceptance Notification: *June 20, 2026*
- Final Papers & Registration Due: *June 27, 2026*

Paper Submission:

- The paper format can be found at the URL below:
http://www.ieee.org/conferences_events/conferences/publishing/templates.html
- The length of the paper is 6 pages including all text, figures, and references. Up to 2 extra pages (for a total of 8 pages) will be available with additional charge.
- In order to facilitate a blind review process, the author's name and address **MUST NOT** appear in the manuscript.
- The manuscript in PDF format **must be submitted via e-mail** to t-hochin[at]haruka.otemon.ac.jp. **Please do NOT upload your manuscript at SNPD 2026-I homepage**, since the submitted papers will be peer-reviewed independently from general sessions in SNPD 2026-I.
- Submission implies the willingness of at least one of the authors to register and present the paper.

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